



VNT008A/9A, VNS008A/9A

N-Channel Enhancement Mode Transistors

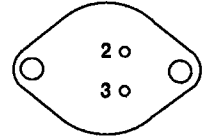
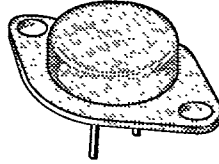
T-39-13

PRODUCT SUMMARY

PART NUMBER	V _{(BR)DSS} (V)	r _{DS(ON)} (Ω)	I _D (A)
VNT008A	650	1.5	5.77
VNS008A	600	1.5	5.77
VNT009A	650	2.0	5.0
VNS009A	600	2.0	5.0

TO-204AA (TO-3)

BOTTOM VIEW



- 1 DRAIN (CASE)
- 2 GATE
- 3 SOURCE

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS	SYMBOL	VNT 008A	VNS 008A	VNT 009A	VNS 009A	UNITS
Drain-Source Voltage	V _{DS}	650	600	650	600	V
Gate-Source Voltage	V _{GS}	±20	±20	±20	±20	V
Continuous Drain Current	T _C = 25°C	5.77	5.77	5.0	5.0	A
	T _C = 100°C	3.65	3.65	3.16	3.16	
Pulsed Drain Current ¹	I _{DM}	15	15	14	14	A
Avalanche Current (See Figure 9)	I _A	5.77	5.77	5.0	5.0	A
Power Dissipation	T _C = 25°C	125	125	125	125	W
	T _C = 100°C	50	50	50	50	
Operating Junction & Storage Temperature Range	T _J , T _{stg}	-55 to 150				°C
Lead Temperature (I _V from case for 10 sec.)	T _L	300				

4

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	R _{thJC}		1.0	K/W
Junction-to-Ambient	R _{thJA}		80	
Case-to-Sink	R _{thCS}	1.0		

¹Pulse width limited by maximum junction temperature (refer to transient thermal impedance data, Figure 11).

VNT008A/9A, VNS008A/9A



T-39-13

ELECTRICAL CHARACTERISTICS (T_J = 25°C Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	TYP	LIMITS		UNIT
				MIN	MAX	
STATIC						
Drain-Source Breakdown Voltage	VNT008A, VNT009A VNS008A, VNS009A	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 2000 μA		650 600	V
Gate Threshold Voltage		V _{GS(th)}	V _{DS} = V _{GS} , I _D = 1000 μA		2.0	4.0
Gate-Body Leakage		I _{GSS}	V _{DS} = 0 V, V _{GS} = ±20 V			±100
Zero Gate Voltage Drain Current		I _{DSS}	V _{DS} = V _{(BR)DSS} , V _{GS} = 0 V			2000
			V _{DS} = 0.8 × V _{(BR)DSS} , V _{GS} = 0 V, T _J = 125°C			
On-State Drain Current ¹		I _{D(ON)}	V _{DS} = 10 V, V _{GS} = 10 V		5.7	A
Drain-Source On-State Resistance ¹	VNT008A, VNS008A VNT009A, VNS009A	r _{DS(ON)}	V _{GS} = 10 V, I _D = 3 A	1.2 1.7		1.5 2.0
	VNT008A, VNS008A VNT009A, VNS009A		V _{GS} = 10 V, I _D = 3 A, T _J = 125°C	2.4 3.4		3.75 6.0
Forward Transconductance ¹		g _{fs}	V _{DS} = 15 V, I _D = 3 A	3.3	3.0	S
DYNAMIC						
Input Capacitance		C _{iss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz	1200		1500
Output Capacitance		C _{oss}		140		150
Reverse Transfer Capacitance		C _{rss}		40		50
Total Gate Charge ²		Q _g	V _{DS} = 0.5 × V _{(BR)DSS} , V _{GS} = 10 V, I _D = 5.7 A	53		75
Gate-Source Charge ²		Q _{gs}		12.9		
Gate-Drain Charge ²		Q _{gd}		26		
Turn-On Delay Time ²		t _{d(on)}	V _{DD} = 325 V, R _L = 130 Ω I _D ≈ 2.5 A, V _{GEN} = 10 V, R _G = 4.7 Ω	15		20
Rise Time ²		t _r		20		25
Turn-Off Delay Time ²		t _{d(off)}		80		85
Fall Time ²		t _f		45		50
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_C = 25°C)						
Continuous Current	VNT008A, VNS008A VNT009A, VNS009A	I _S			5.77 5.0	A
Pulsed Current ³	VNT008A, VNS008A VNT009A, VNS009A	I _{SM}			15 14	
Forward Voltage ¹	VNT008A, VNS008A VNT009A, VNS009A	V _{SD}	I _F = I _S , V _{GS} = 0 V		2.5 2.0	V
Reverse Recovery Time		t _{rr}	I _F = I _S , di _F /dt = 100 A/μs	400		ns
Reverse Recovery Charge		Q _{rr}		2.5		

¹Pulse test: Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

²Independent of operating temperature.

³Pulse width limited by maximum junction temperature (refer to transient thermal impedance data, Figure 11).



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TYPICAL CHARACTERISTICS (25°C Unless Otherwise Specified)

T-39-13

Figure 1. Output Characteristics

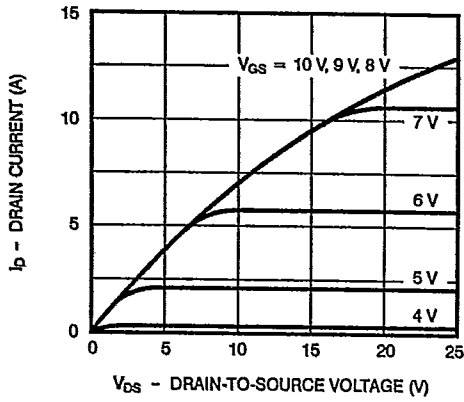


Figure 2. Transfer Characteristics

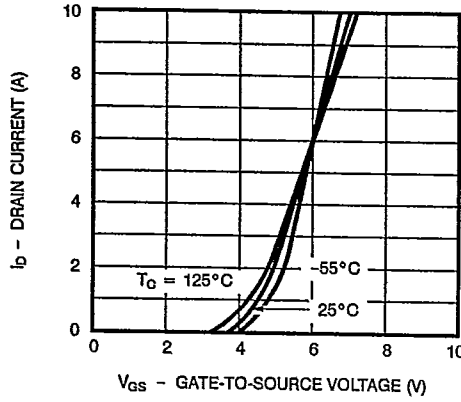


Figure 3. Transconductance

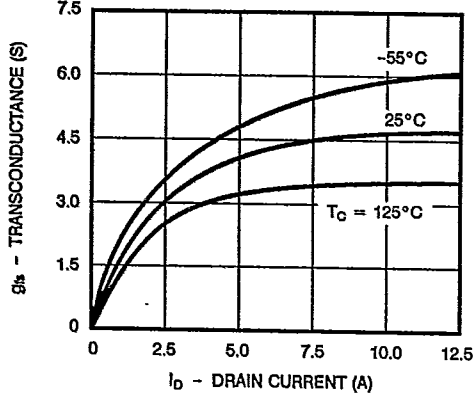
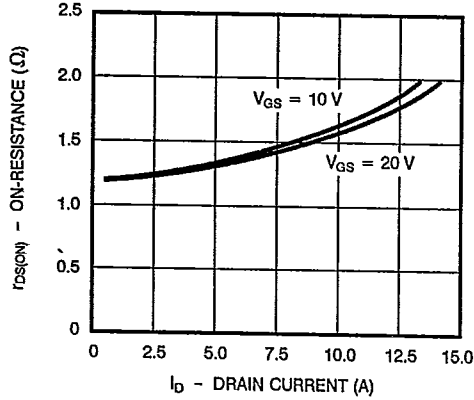


Figure 4. On-Resistance



4

Figure 5. Capacitance

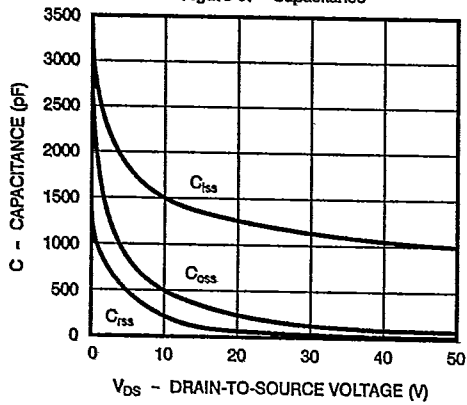
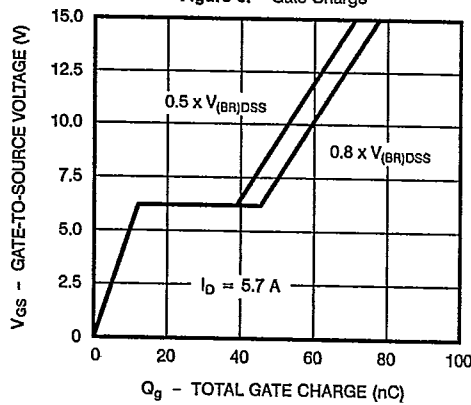


Figure 6. Gate Charge



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TYPICAL CHARACTERISTICS (Cont'd)

T-39-13

Figure 7. On-Resistance vs. Junction Temperature

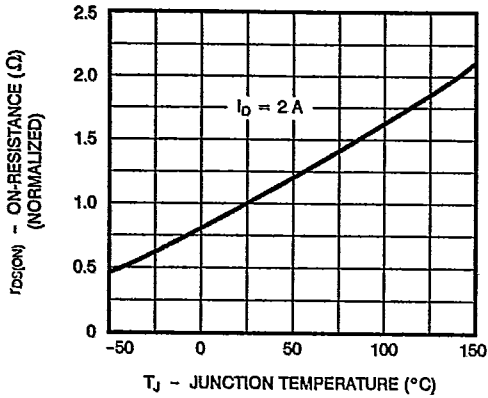
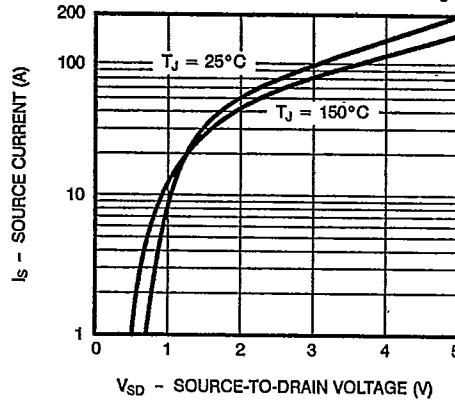


Figure 8. Source-Drain Diode Forward Voltage



THERMAL RATINGS

Figure 9. Maximum Avalanche and Drain Current vs. Case Temperature

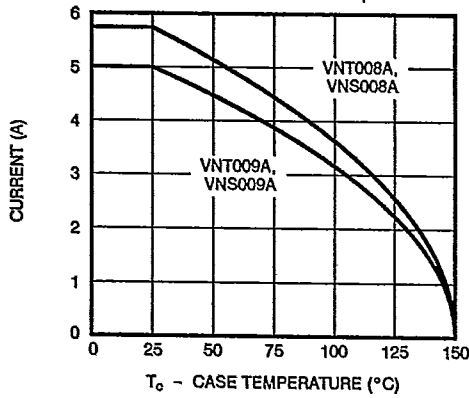


Figure 10. Safe Operating Area

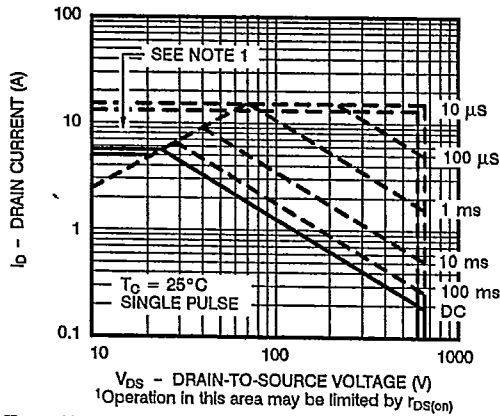


Figure 11. Normalized Effective Transient Thermal Impedance, Junction-to-Case

